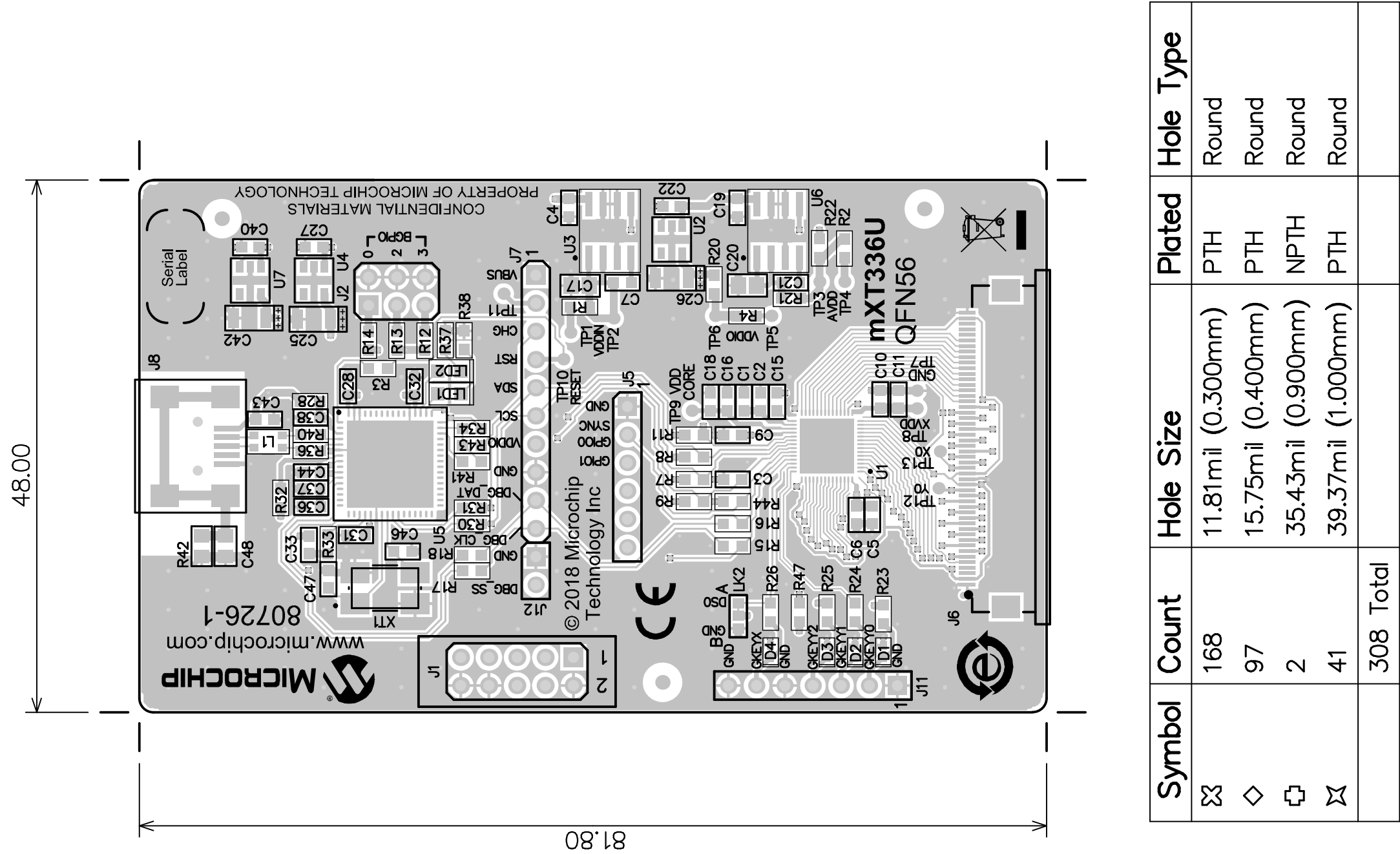




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Title: ATMXT336U EVK Control Board				Layer BOARD OUTLINE		
Number: 80726		Iss: 1	ECN: N/A	TOP SILKSCREEN TOP COPPER		
Dm: P.Cassidy	Chk'd:	App'd:	CAD:			
Design created from schematic: B-2840						
Date: 14th Aug 2018						
 MICROCHIP		Filename: 80726.PcbDoc				
		This version supercedes all other versions. Please destroy all previous versions.				
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Iss	Notes			ECN	Dm	Date
A0	First Issue			N/A	DC	1st June 2015
A1	Removed duplicate names			N/A	DC	12th June 2015
A2	Changed to MCHP branding			N/A	PFC	4th July 2017
1	Added standards logos			N/A	PFC	14th Aug 2018

Material: FR-4 1.6mm 4 layer PTH, 35um copper

Finish: ENIG (Electroless Nickel Immersion Gold)

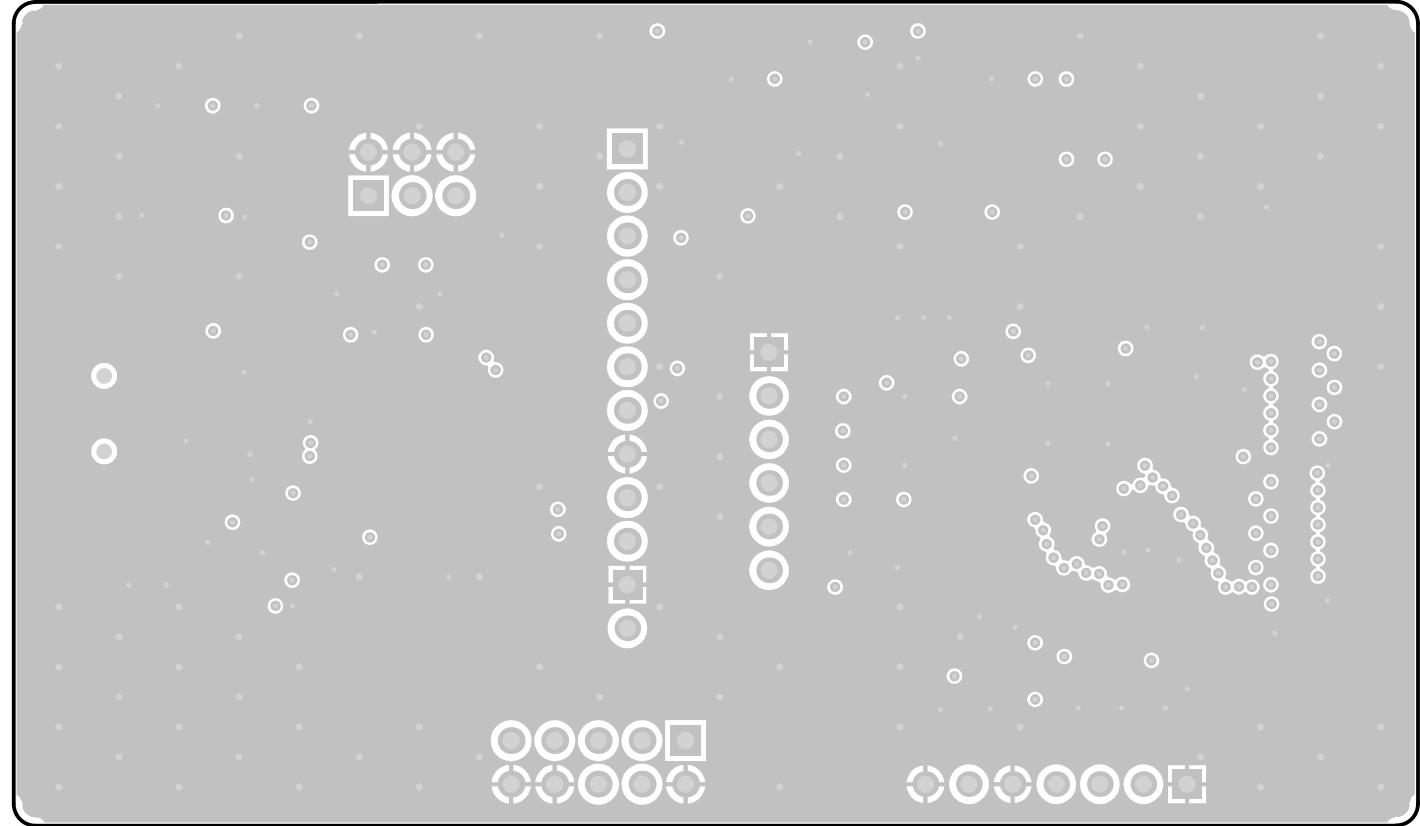
Solder mask both sides in BLACK

Silkscreen top side in WHITE

All dimensions in millimetres

View on top (component) side

All components and materials used must be RoHS compliant
as described in European Parliament Directive 2002/95/EC



Title: ATMXT336U EVK Control Board				Layer BOARD OUTLINE		
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A1	Removed duplicate names			N/A	DC	12th June 2015
A2	Changed to MCHP branding			N/A	PFC	4th July 2017
1	Added standards logos			N/A	PFC	14th Aug 2018

Material: FR-4 1.6mm 4 layer PTH, 35um copper

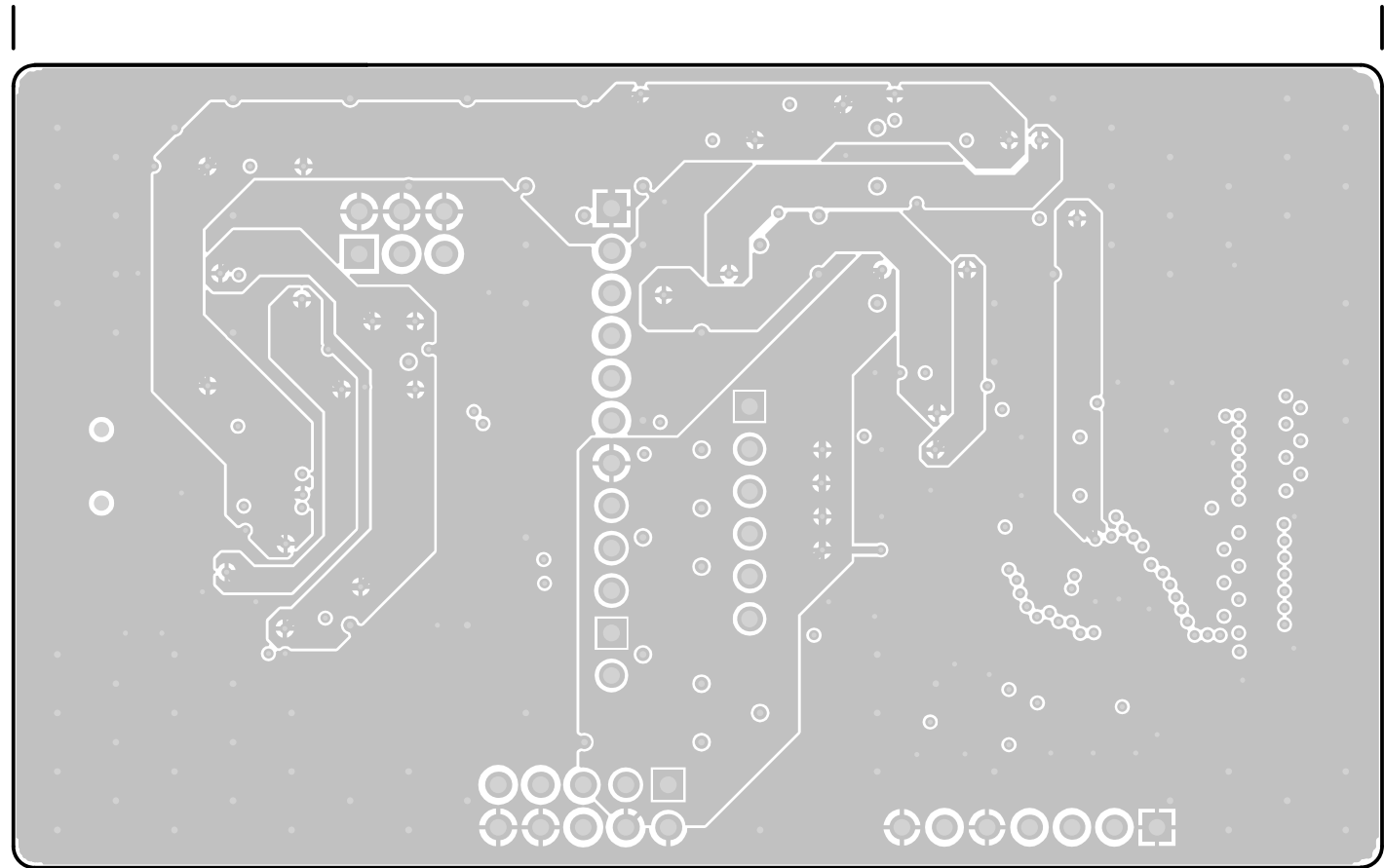
Finish: ENIG (Electroless Nickel Immersion Gold)

Solder mask both sides in BLACK

Silkscreen top side in WHITE

All dimensions in millimetres

View on top (component) side



Title: ATMXT336U EVK Control Board				Layer BOARD OUTLINE		
Number: 80726		Iss: 1		ECN: N/A		
Dm: P.Cassidy		Chk'd:		App'd: CAD:		
Design created from schematic: B-2840						
Date: 14th Aug 2018		Filename: 80726.PcbDoc				
 MICROCHIP		This version supercedes all other versions. Please destroy all previous versions.				
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Iss	Notes			ECN	Dm	Date
A0	First Issue			N/A	DC	1st June 2015
A1	Removed duplicate names			N/A	DC	12th June 2015
A2	Changed to MCHP branding			N/A	PFC	4th July 2017
1	Added standards logos			N/A	PFC	14th Aug 2018

Material: FR-4 1.6mm 4 layer PTH, 35um copper

Finish: ENIG (Electroless Nickel Immersion Gold)

Solder mask both sides in BLACK

Silkscreen top side in WHITE

All dimensions in millimetres

View on top (component) side

All components and materials used must be RoHS compliant
as described in European Parliament Directive 2002/95/EC

as described in European Parliament Directive 2002/95/EC
All components and materials used must be RoHS compliant

View on top (component) side

All dimensions in millimetres

Silkscreen top side in WHITE

Solder mask both sides in BLACK

Finish: ENIG (Electroless Nickel Immersion Gold)

Material: 32mm PTH, 4mm FR-4 prepreg

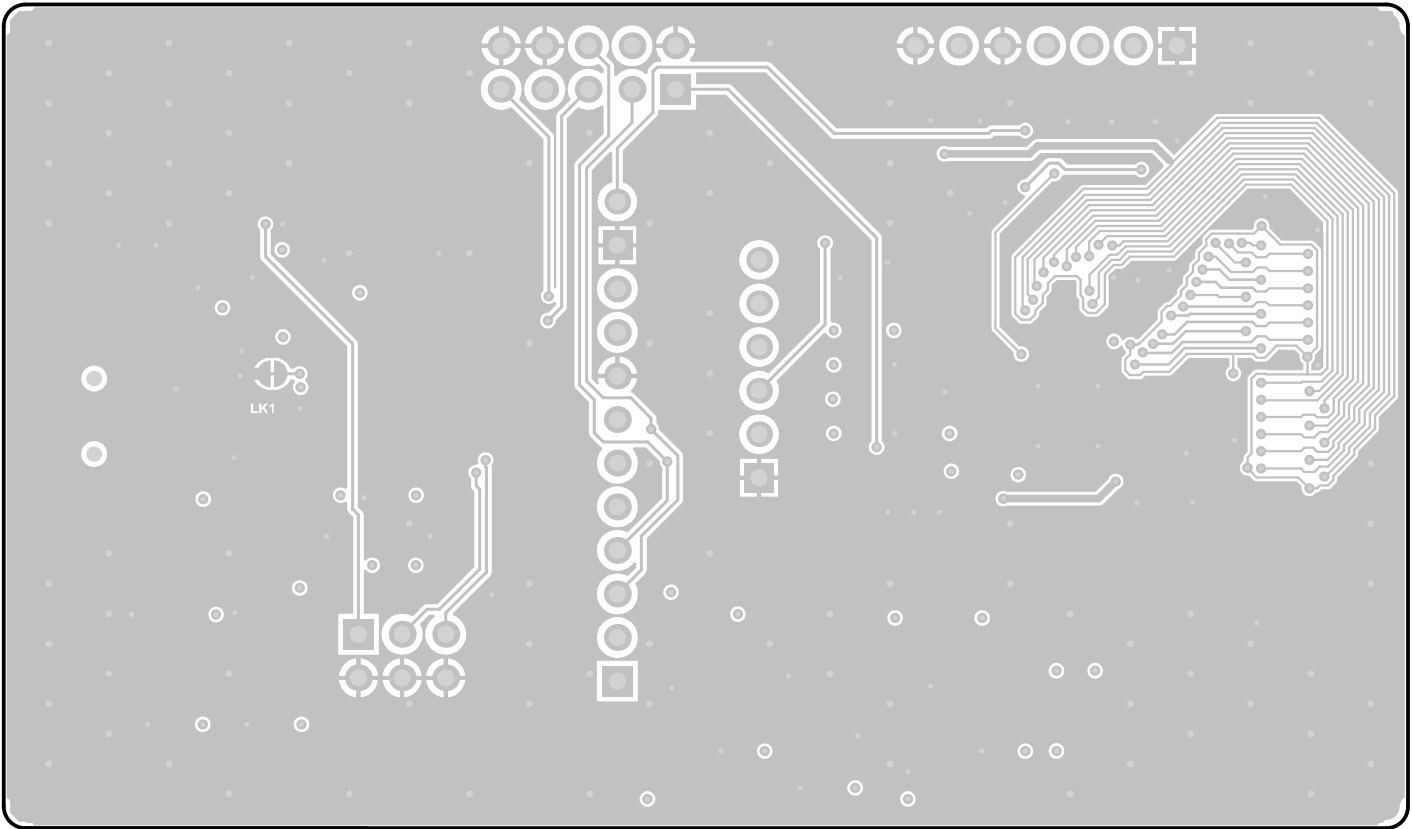
1	Added standards logos	N/A	PFC	14th Aug 2018
A2	Changed to MCHP branding	N/A	PFC	4th July 2017
A1	Removed duplicate names	N/A	DC	15th June 2015
A0	First issue	N/A	DC	1st June 2015
Iss	Notes	ECN	Dm	Date

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Date: 14th And 2018		Please destroy all previous versions. This version supersedes all other versions.	
Design created from schematic: B-5840		Filename: 80256.pcpDoc	
P.Cassidy	CHK,q:	Abb,q:	CAD:
Number: 80256	Iss: 1	ECN: N/A	BOARD OUTLINE Layer
Title: ATMXL336N EVK Control Board		BOARD OUTLINE Layer	



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